TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HCT00AP, TC74HCT00AF

#### Quad 2-Input NAND Gate

The TC74HCT00A is a high speed CMOS 2-INPUT NAND GATE fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

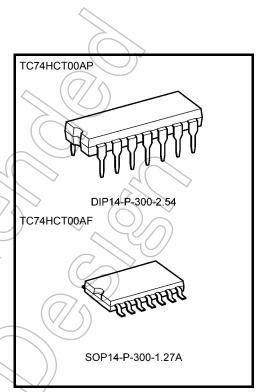
This device may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

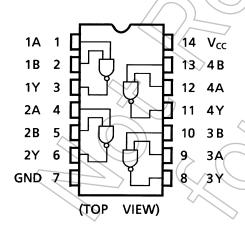
- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 1 \mu A \text{ (max)}$  at  $T_{A} = 25 \text{°C}$
- Compatible with TTL outputs:  $V_{IH} = 2 V (min)$  $V_{IL} = 0.8 V (max)$
- Wide interfacing ability: LSTTL, NMOS, CMOS
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: t<sub>pLH</sub> ≃ t<sub>pHL</sub>
- Pin and function compatible with 74LS00



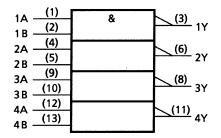
Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.)

#### **Pin Assignment**



#### **IEC Logic Symbol**



#### **Truth Table**

Α	В	Υ
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7	
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	)) v
Input diode current	l <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	(ICC	£50	mA
Power dissipation	(PD)	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

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# Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	٧
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	٧
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Т		Ta = 25°C		Ta = -40 to 85°C		Unit		
					Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	_		4.5 to 5.5	2.0	_		2.0	_	V
Low-level input voltage	V <sub>IL</sub>	_		4.5 to 5.5	-	- (	0.8	)>_	0.8	٧
High-level output voltage	V <sub>IN</sub>	$I_{OH} = -20 \mu A$	4.5	4.4	4.5	79	4.4	_	V	
	VOH	= V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -4 mA	4.5	4.18	4.31		4.13	_	v
Low-level output	Low-level output	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 20 \ \mu A$	4.5	-((	0.0	> 0.1	_	0.1	V
voltage	VOL		$I_{OL} = 4 \text{ mA}$	4.5		0.17	0.26		0.33	٧
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	/ <del>/</del>		±0.1	/A	±1.0	μА
	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		1.0	7-/	10.0	μА
Quiescent supply current I <sub>C</sub>		Per input: $V_{IN} = 0.5 \text{ V or } 2.4 \text{ V}$ Other input: $V_{CC}$ or GND		5.5		_	2.0		2.9	mA

# AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $T_a = 25^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>			4	8	ns
Propagation delay time	t <sub>pLH</sub>			10	20	ns

### AC Characteristics ( $C_L = 50 \text{ pF}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
4			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Output transition time	tTLH		4.5	_	8	15	_	19	no
Output transition time	t <sub>THL</sub>		5.5	_	7	14	_	18	ns
Propagation delay time	t <sub>р</sub> LH		4.5	_	13	19	_	24	ns
	t <sub>pHL</sub>		5.5		12	17		21	
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)			_	19	_	_	_	pF

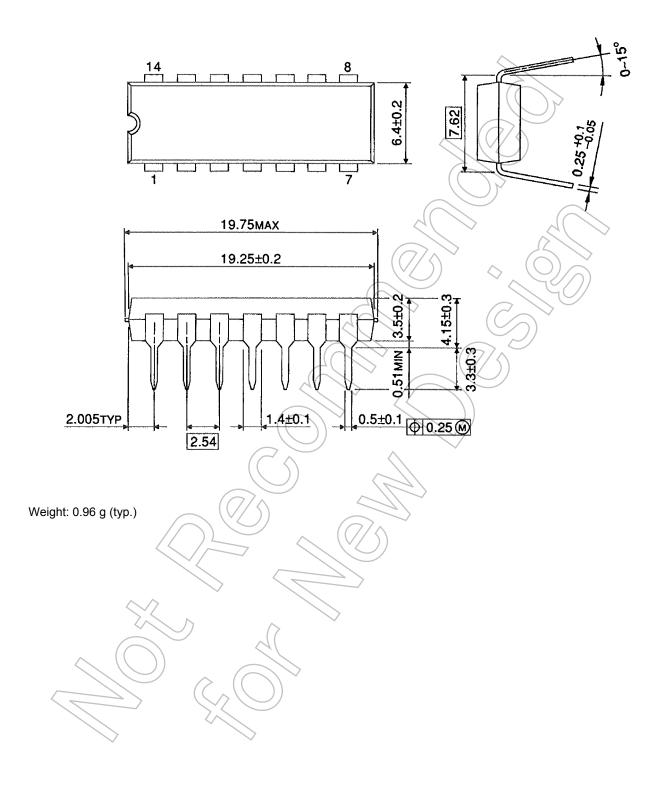
Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per gate)

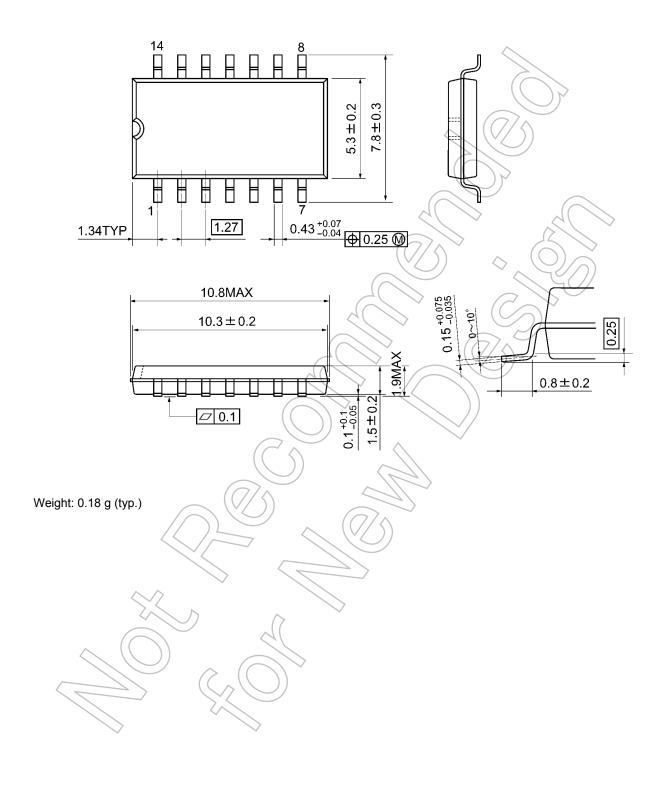
## **Package Dimensions**

DIP14-P-300-2.54 Unit: mm



## **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



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